

CHIP NO. 2C5574

LINE SOURCE — DTL0420

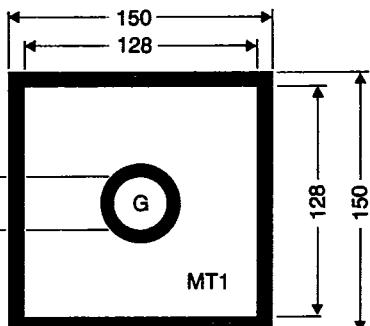


Device assembled from this die type are similar to or better than the following device types:

2N5567
2N5568
2N5569
2N5570
2N5571

2N5572
2N5573
2N5574
MAC15,A Series

**TRIAC — Bidirectional
Triode Thyristor**



Metallized bottom of backside is MT2

METALLIZATION —

Top Al, Cr, Cu, Au
Back Al, Cr, Cu, Au

CHIP THICKNESS 9.5 ± 0.5 mils

BONDING PAD SIZE:

Anode 128 mils
Cathode 128 mils
Gate 25 mils
Glassivation yes

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, See Note 1)

Parameter	Test Conditions	Min	Max	Unit
I_{DRM}	$V_D = 400$ V _{DRM}	—	50	µAdc
I_{GT}	$V_D = 12$ Vdc, $R_L = 100 \Omega$ MT2(+), G(+) MT2(+), G(−) MT2(−), G(−) MT2(−), G(+)	— — — —	50 50 50 75	mAdc
V_{GT}	$V_D = 12$ Vdc, $R_L = 100 \Omega$ MT2(+), G(+) MT2(+), G(−) MT2(−), G(−) MT2(−), G(+)	— — — —	2.0 2.0 2.0 2.5	Volts
I_H	$V_D = 12$ Vdc, $I_{TH} = 0.2$ Adc	—	30	mAdc

NOTES: 1. Because of the limitation of probe testing, dc parameters are tested. These parameters must be measured using pulse techniques pulse width = $300 \mu\text{A}$ duty cycle $\leq 2\%$.